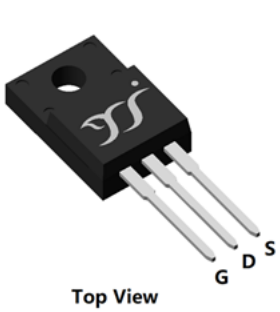
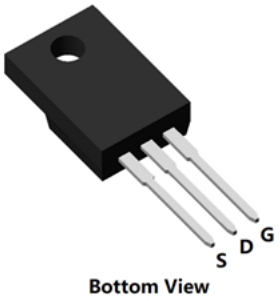
N-Channel Enhancement Mode Field Effect Transistor

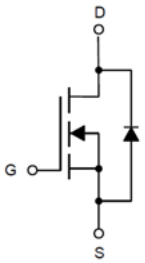


Top View



Bottom View

ITO-220AB



Product Summary

- V_{DS} 650V
- I_D 4.3A
- $R_{DS(ON)}$(at V_{GS}=10V) ＜960mΩ
- 100% EAS Tested
- 100% ▽V_{DS} Tested

General Description

- Super Junction High Voltage MOSFET technology
- Ultra Low Gate Charge Cause Lower Driving Requirement
- Low On-resistance and Low Conduction Loss
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- LED Lighting
- Adapter

■ Limiting Values

Parameter	Conditions		Symbol	Min	Max	Unit
Drain-source Voltage			V_{DS}	-	650	V
Gate-source Voltage			V_{GS}	-30	30	
Continuous Drain Current (Note 1,2)	Steady-State	T_A=25℃,V_{GS}=10V	I_D	-	0.92	A
		T_A=100℃,V_{GS}=10V		-	0.58	
Continuous Drain Current (Note 1,3)	Steady-State	T_C=25℃,V_{GS}=10V		-	4.3	
		T_C =100℃,V_{GS}=10V		-	2.7	
Pulsed Drain Current	T_C=25℃,t_p≤10μs		I_{DM}	-	15	
Maximum Body-Diode Continuous Current	T_C=25℃		I_S		4.3	
Maximum Body-Diode Pulsed Current	T_C=25℃,t_p≤10μs		I_{SM}	-	15	
Avalanche Energy (non-repetitive)	T_J=25℃,V_G=10V,R_G=25Ω,L=30mH,I_{AS}=2.3A		EAS	-	79.3	mJ
Total Power Dissipation (Note 1,2)	Steady-State	T_A=25℃	P_D	-	1.95	W
		T_A=100℃		-	0.78	
Total Power Dissipation (Note 1,3)	Steady-State	T_C=25℃		-	41.6	
		T_C =100℃		-	16.6	
MOSFET dv/dt Ruggedness	T_J=25℃,V_{DS}=0…325V,ID<=3.3A,Rg=0Ω		dv/dt	-	22.6	V/ns
Reverse Diode dv/dt	T_J=25℃,V_{DS}=0…325V,ID<=3.3A,di/dt=200A/us		dv/dt	-	7	
Maximum Diode Commutation Speed	T_J=25℃,V_{DS}=0…325V,ID<=3.3A,Rg=0Ω		dif/dt	-	1375	A/us
Insulation withstand voltage	T_J=25℃,Vrms, t=60s		V_{ISO}	-	2.5	KV
Junction and Storage Temperature Range			T_J ,T_{STG}	-55	150	℃

■Thermal Resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	Steady-State	$R_{\theta JA}$	-	64	℃/W
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	-	3	

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJF960C65BHJ	B1	F960C65BHJ	50	/	5000	Tube

■ Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V,I_D=250μA,Tj=25℃	650	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=650V,V_{GS}=0V,Tj=25℃	-	-	1	μA
		V_{DS}=650V,V_{GS}=0V,Tj=150℃	-	-	100	
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±30V,V_{DS}=0V,Tj=25℃	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA,Tj=25℃	2.5	3.3	4.1	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=10V,I_D=2A,Tj=25℃	-	760	960	mΩ
		V_{GS}=10V,I_D=2A,Tj=150℃	-	1800	2270	
Diode Forward Voltage	V_{SD}	I_S=4.3A,V_{GS}=0V,Tj=25℃	-	0.86	1.2	V
Gate Resistance	R_G	f=1MHz,Tj=25℃	-	18	-	Ω
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=325V,V_{GS}=0V,f=1MHz,Tj=25℃	-	380	-	pF
Output Capacitance	C_{oss}		-	16	-	
Reverse Transfer Capacitance	C_{rss}		-	4.3	-	
Effective Output capacitance, Energy Related	$C_{o(er)}$	V_{DS}=0…325V,V_{GS}=0V,f=1MHz, Tj=25℃	-	22	-	
Effective Output Capacitance, Time Related	$C_{o(tr)}$		-	86	-	
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V,V_{DS}=325V,I_D=4.3A,Tj=25℃	-	11.6	-	nC
Gate-Source Charge	Q_{gs}		-	2.1	-	
Gate-Drain Charge	Q_{gd}		-	5.7	-	
Reverse Recovery Charge	Q_{rr}	I_F=4.3A,di/dt=100A/μs,V_{GS}=0V, V_R=325V,Tj=25℃	-	1710	-	nC
Reverse Recovery Time	t_{rr}		-	223	-	ns
Peak Reverse Recovery Current	I_{rrm}		-	14	-	A
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V,V_{DS}=325V,I_D=4.3A, R_{GEN}=3Ω,Tj=25℃	-	21	-	ns
Turn-on Rise Time	t_r		-	25	-	
Turn-off Delay Time	$t_{D(off)}$		-	30	-	
Turn-off Fall Time	t_f		-	28	-	

Note：

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. The value of $R_{\theta JA}$ is measured in the still air environment with T_A =25℃.The maximum allowed junction temperature of 150℃.
3. Thermal resistance from junction to soldering point (on the exposed drain pad).

■Typical Electrical and Thermal Characteristics Diagrams

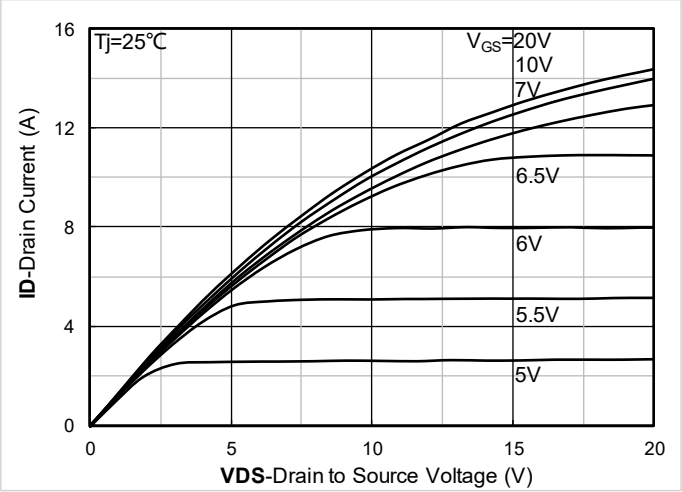


Figure 1. Output Characteristics; typical values

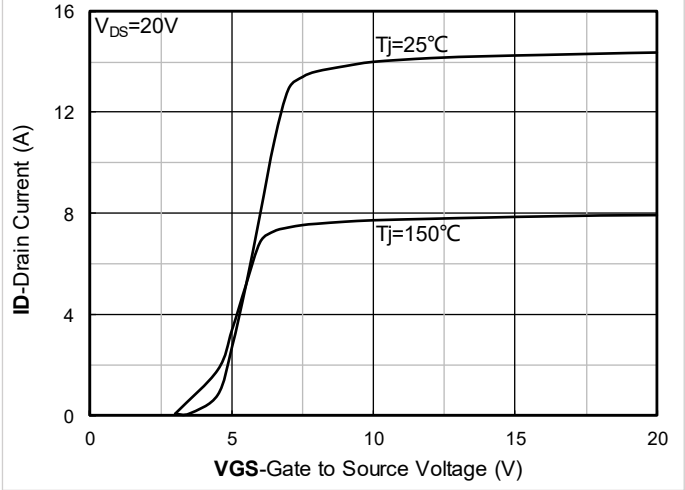


Figure 2. Transfer Characteristics; typical values

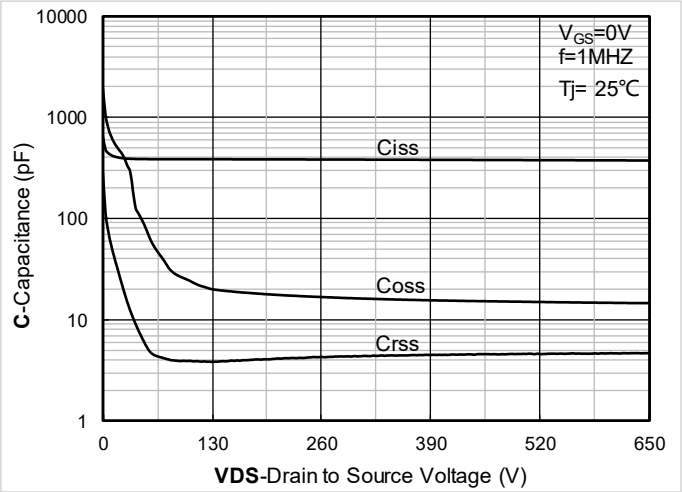


Figure 3. Capacitance Characteristics; typical values

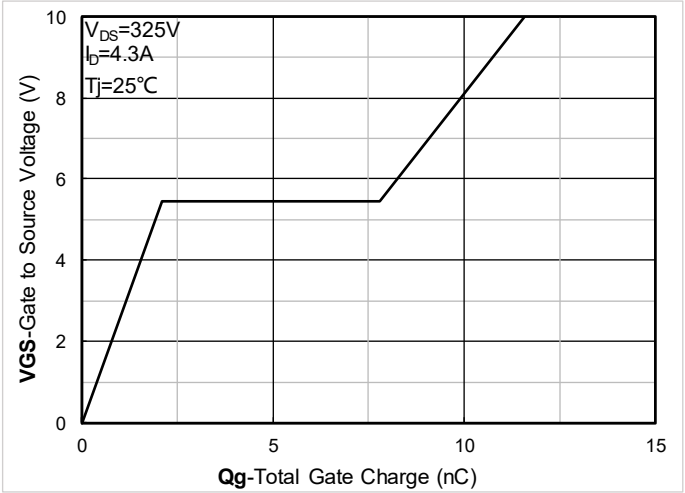


Figure 4. Gate Charge; typical values

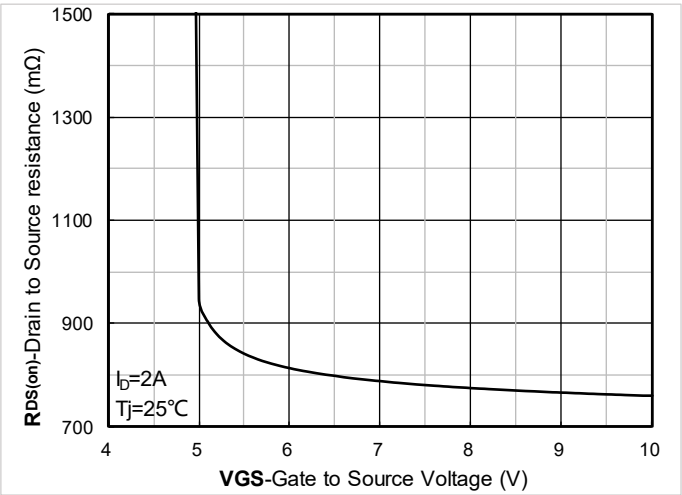


Figure 5. On-Resistance vs. Gate to Source Voltage; typical values

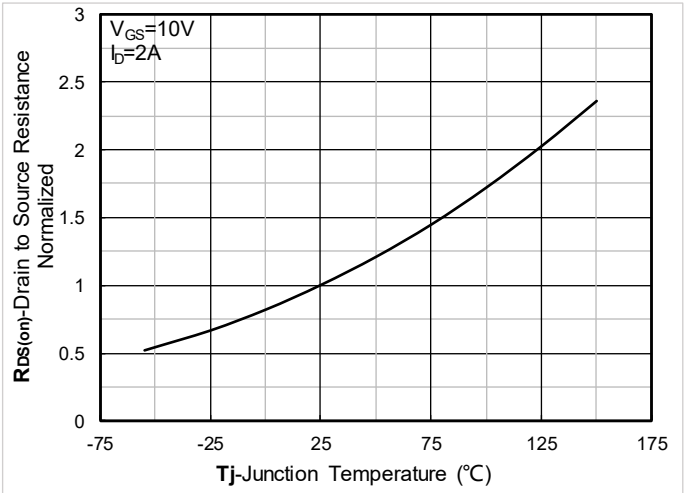


Figure 6. Normalized On-Resistance

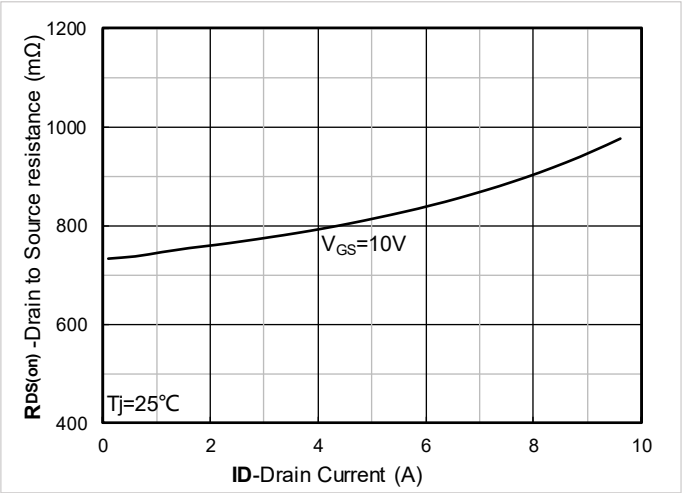


Figure 7. $R_{DS(on)}$ vs. Drain Current; typical values

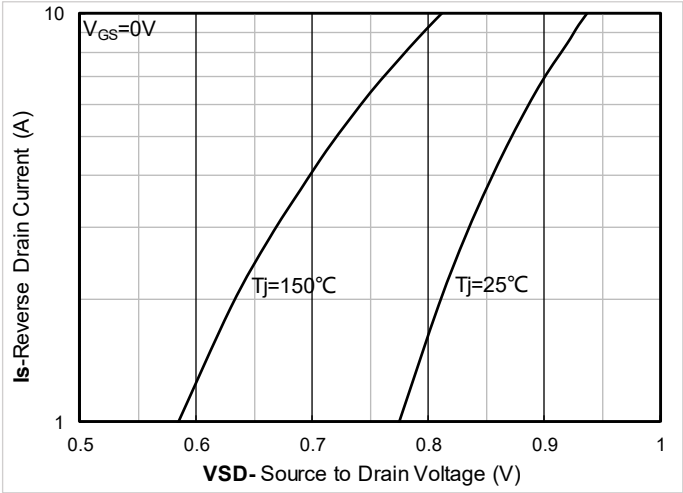


Figure 8. Forward characteristics of reverse diode; typical values

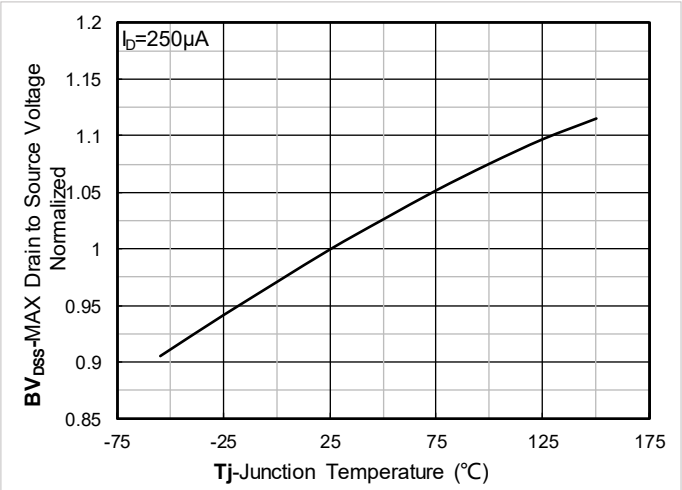


Figure 9. Normalized breakdown voltage

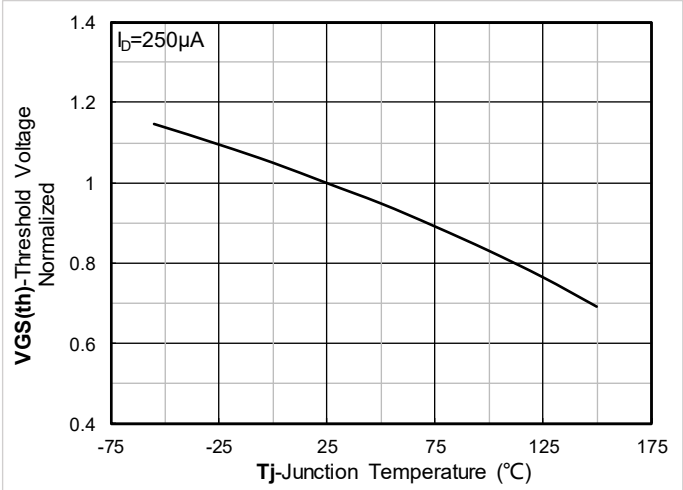


Figure 10. Normalized Threshold voltage

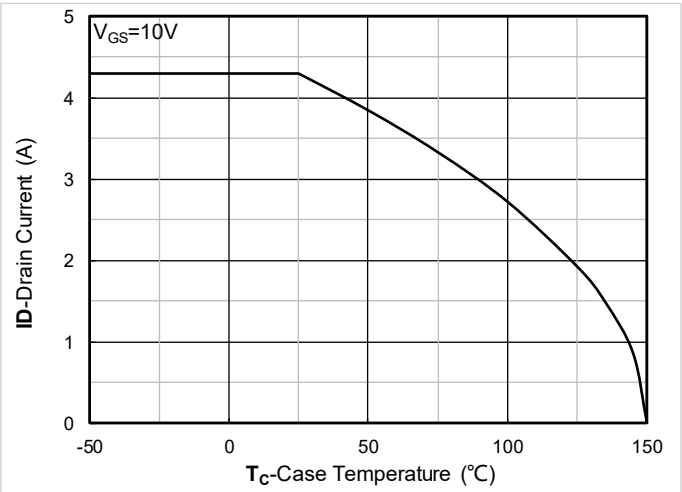


Figure 11. Current dissipation

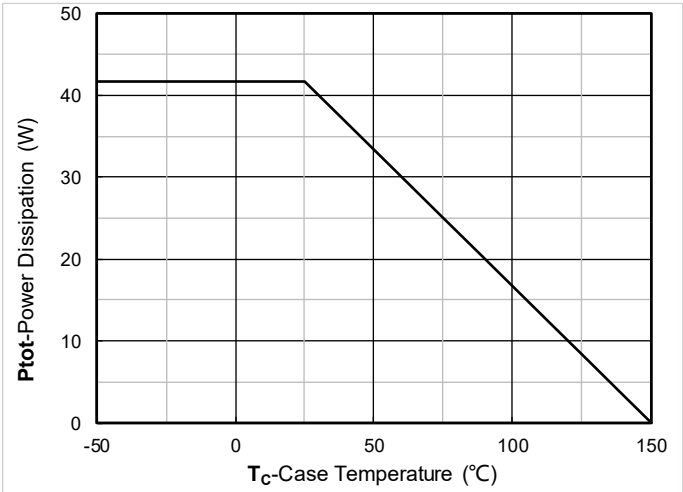


Figure 12. Power dissipation

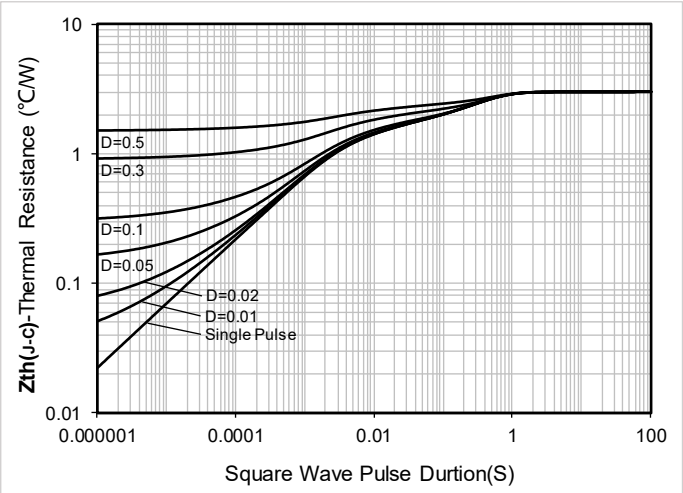


Figure 13. Maximum Transient Thermal Impedance

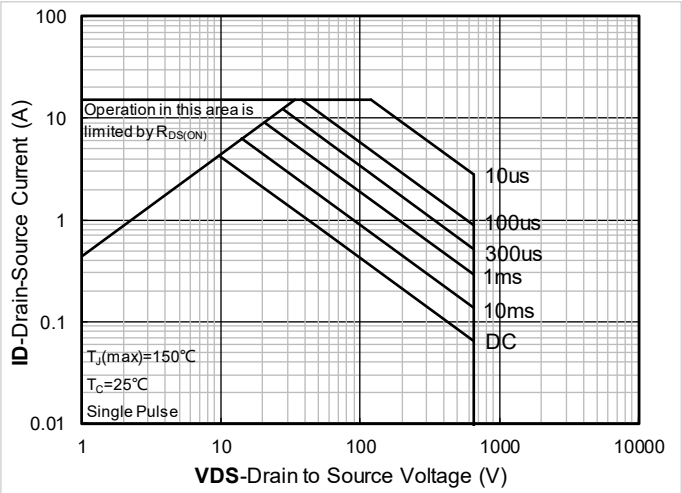


Figure 14. Safe Operation Area

■ Test Circuits & Waveforms

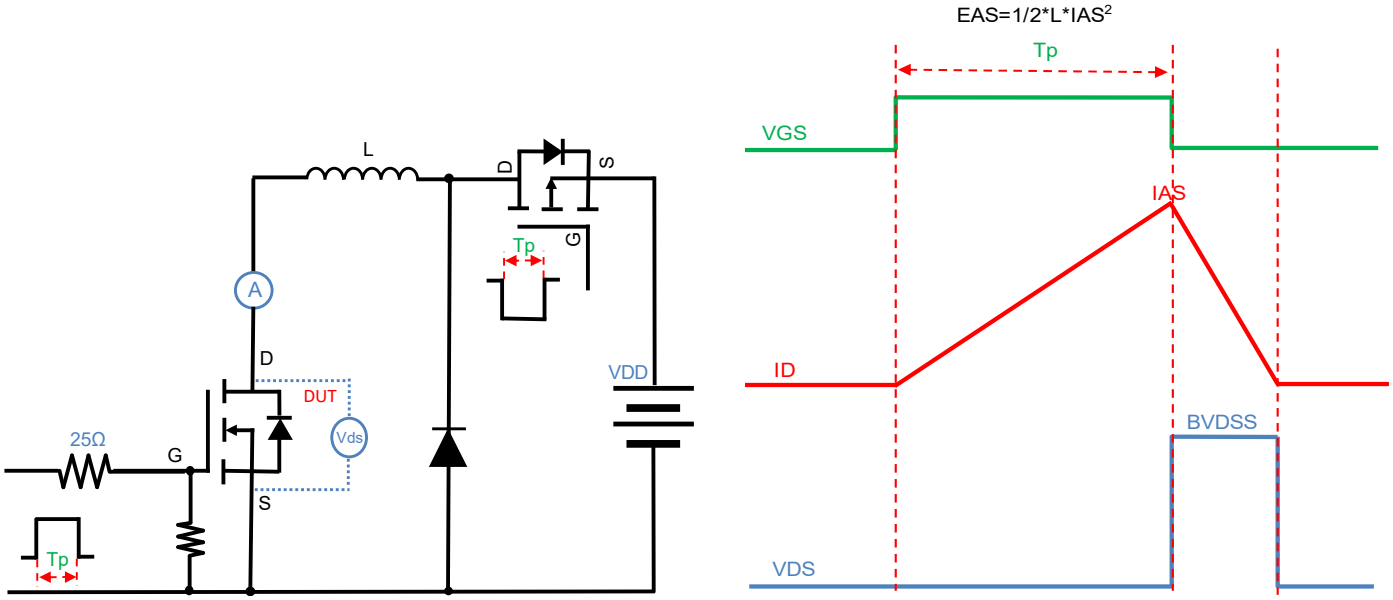


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

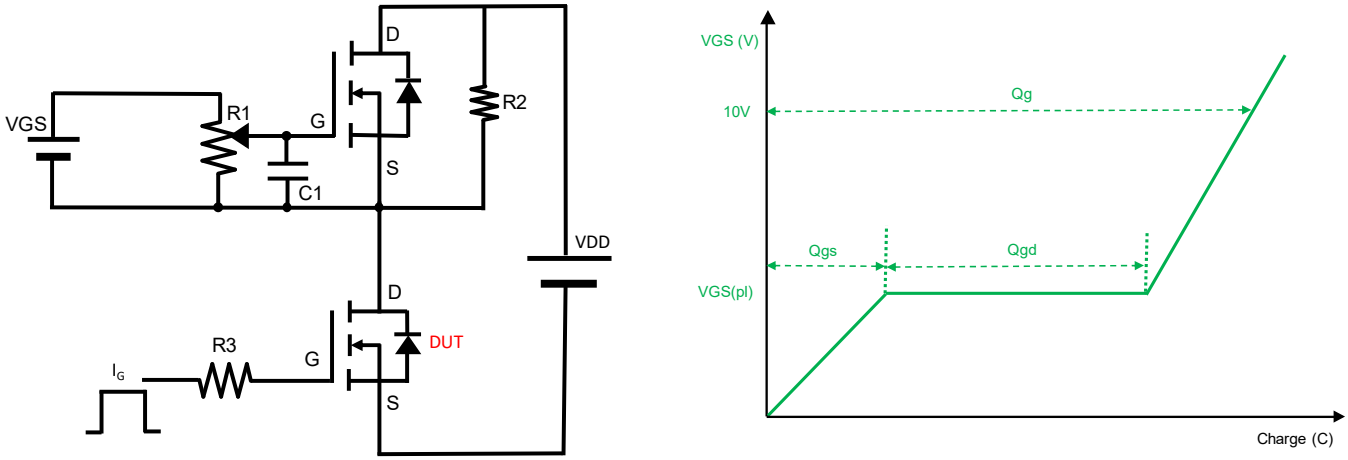


Figure B. Gate Charge Test Circuit & Waveform

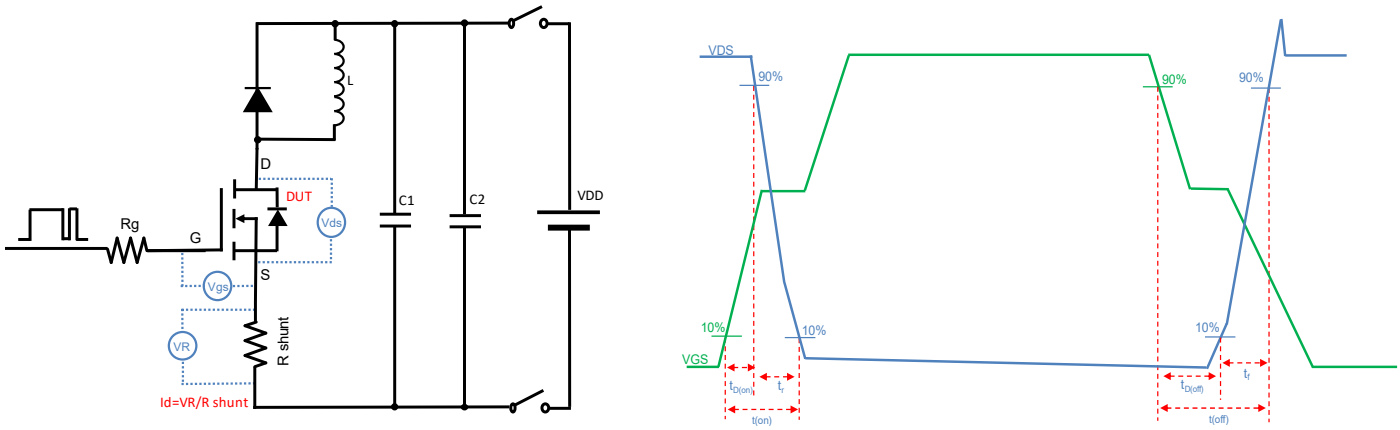


Figure C. Resistive Switching Test Circuit & Waveform

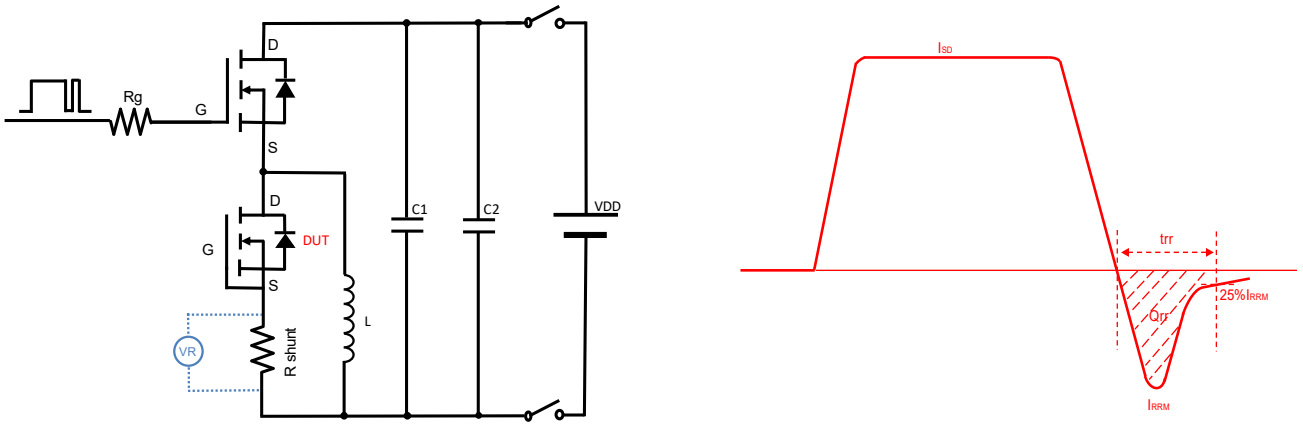
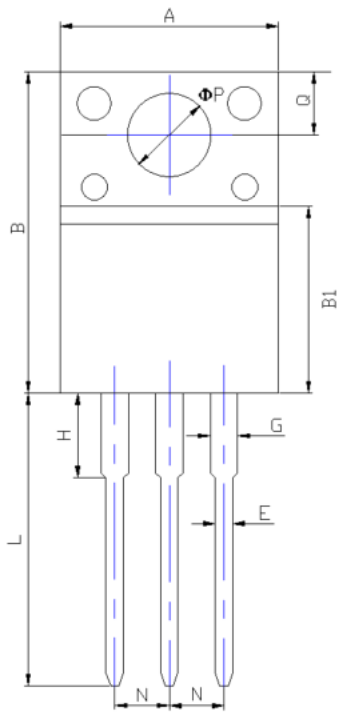
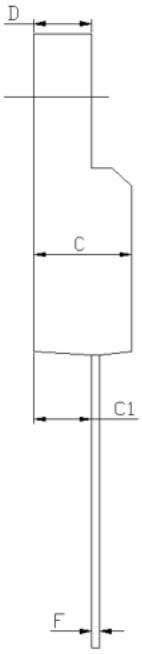


Figure D. Diode Recovery Test Circuit & Waveform

■ ITO-220AB-E Package information



TOP VIEW

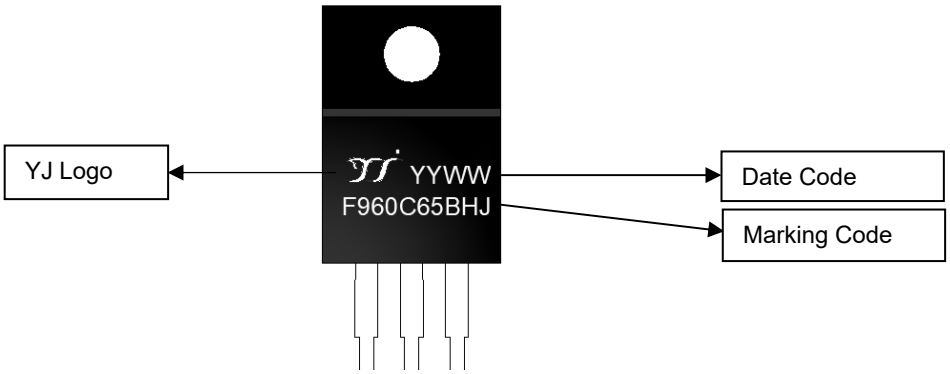


SIDE VIEW

DIMENSIONS				
SYMBOL	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.390	0.406	9.900	10.300
B	0.610	0.633	15.500	16.100
B1	0.350	0.374	8.900	9.500
C	0.181	0.189	4.600	4.800
C1	0.087	0.110	2.200	2.800
D	0.096	0.104	2.450	2.650
E	0.028	0.035	0.700	0.900
F	0.016	0.024	0.400	0.600
G	0.044	0.056	1.120	1.420
H	0.134	0.150	3.400	3.800
L	0.496	0.512	12.600	13.000
N	0.100BSC.		2.540BSC.	
Q	0.126	0.142	3.200	3.600
ΦP	0.122	0.130	3.100	3.300

NOTE:
1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.

■ Marking Information



Note：
1. All marking is at middle of the product body
2. All marking is in laser printing
3. F960C65BHJ is marking code, YYWW is date code, “YY” is year, “WW” is week
4. Body color: Black

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